



EL465779215

Inventor: Chris Parf niuk et al.

Title: Methods of Bonding First and Second Masses to One Another, and Methods of Bonding Physical Vapor Deposition Target Materials To Backing Plate Materials

Assignee: Honeywell International, Inc.

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INFORMATION DISCLOSURE STATEMENT
PURSUANT TO 37 C.F.R. §§ 1.56, 1.97 AND 1.98

In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, the Examiner's attention is directed to the references listed on the attached Form PTO-1449 and copies of which are attached. No admission is made regarding whether all the submitted references are prior art.

Citation of these references is respectfully requested.

Respectfully submitted,

Date:

11/13/01

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